



MicroTechnology

NEWS

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C-MAC MicroTechnology joins SBAC (The Society of British Aerospace Companies)

C-MAC MicroTechnology has joined SBAC, the UK's national trade association representing companies supplying civil air transport, defence, security and space. As a leading supplier of specialised, high reliability electronic systems, modules and components for harsh environments in all these sectors, C-MAC will use its expertise to contribute to the ongoing development and success of the aerospace business in Britain.

Welcoming C-MAC MicroTechnology, Oliver Greening, Director of Strategy and Services Development at SBAC said "We welcome C-MAC MicroTechnology as a member of SBAC. This is an exciting time for our industry, and we look forward to working with C-MAC as we further consolidate and build on our industry's success."

Paul Hill, General Manager, Aerospace, Defence and Energy at C-MAC MicroTechnology said, 'As a global player in a key industry sector in Britain, C-MAC looks forward to being a member of SBAC and working with the organisation to further the interests of the British aerospace industry both here and abroad'.

NOTES FOR EDITORS:

Headed by Indro Mukerjee, **C-MAC MicroTechnology** is the world leader in high-reliability electronic systems, modules and components for harsh environments such as extremes of temperature, vibration and shock. C-MAC operates primarily within the defence, aerospace, automotive, space, medical and specialised industrial sectors. The head office is in Wooburn Green, UK and the company has design and manufacturing facilities in the UK, France,

Belgium and Canada, with additional dedicated sales and customer support teams throughout Europe and the USA. C-MAC has an extensive intellectual property portfolio and considerable electronics design and manufacturing expertise geared to its target industries.

Technologies and manufacturing processes at production sites at Great Yarmouth in the UK, Sherbrooke in Canada and Ronse in Belgium include thick-film printing on ceramic and other substrates, surface-mount hybrid circuits, DC/DC power modules, direct-attach flipchip, low-temperature cofired ceramic (LTCC), chip-on-board (COB), multichip module (MCM) assemblies and PCB assembly. These manufacturing resources are complemented by an integrated design-to-test service encompassing ASIC design as well as analogue, digital, RF, mixed-mode and thermal simulation. C-MAC also operates a UKAS-approved test facility, where an extensive range of product qualifications and tests are carried out to internationally recognized standards.

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